



tML® HD - FO Breakout Module 2x MPO/MTP® with Pins/8x LC Duplex 50/125µ OM4, SR4





tML® tde Modular Link

tML® is a patented, modular cabling system consisting of the three key components module, trunk cable and rack mount enclosure. The system components are 100 percent manufactured, pre-assembled and tested in Germany. They enable plug-and-play installation on site – especially in data centres, but also in industrial environments – within the shortest possible time. Heart of the system are the rear MPO/MTP® and Telco connectors, which can be used to connect at least six or twelve ports at a time. Depending on the module configuration, transfer rates of up to 400G are currently possible with SR4. The fibre optic and TP modules can be used together in a module carrier with a very high port density. The tde offers its tML® cabling system as a proven tML® standard system and in the highly innovative variants tML® 12, tML® 24, tML® 32 and now tML® 24+ System for extreme scalability and very easy migration to higher transmission rates such as 40G, 100G, 200G, 400G and 800G and more.

The tML® HD Breakout Module is intended for the installation in the tML® Rack Mount Enclosure 1U (for 8 x Modules). The tML® HD Breakout Module can be used only in combination with the tML® HD patch cord.



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Technical Data

The end faces of the connectors are optimized by means of Lasercleaving and machine polish. The MPO/MTP® plug has a defined fiber height of $1 - 3.5\mu$. The max. adjacent fiber height difference is $0.2\mu m$ and for all fibers $0.3\mu m$. All system components (modules, trunk cables and patch cords) are co-ordinated for the reaching of the performance particularly. The module is marked with sequential serial number and article number. The modules are ROHS compliant.

| Entry | 2 x MPO/MTP®Male Adapter (magenta) front |
|-------|--|
| Exit | 8 x LC Duplex Adapter (magenta) front |
| Tests | Interferometer, Insertion Loss, Return Loss and Visual Final Inspection; all measured values are electronically archived |
| | QS-Managementsystem ISO 9001, ISO 14001 and TL 9000 |

| Box | Calvanized steel sheet | |
|-------------|------------------------|--|
| Front Panel | Stainless steel | |
| Dimensions | 110 x 108 x 20 mm | |

FO Adapters

| Туре | LC Duplex |
|-----------------|--------------------------|
| Application | Multimode OM4 |
| Design | One-Piece without flange |
| Connector style | SC simplex |
| Color | Magenta |
| Material | Plastic |
| Sleeve | Zirkonia Staight Split |
| Shutter | |
| Manufacturer | tde |

FO Connectors

| Connector Type | LC Unibody Simplex |
|-----------------------|---|
| Housing | Plastic, Magenta |
| Ferrule | Zirkonia Staight Split, Spring-loaded Axially |
| Ferrule Hole | 126 μ |
| Mating Cycles | 1.000 |
| Operating Temperature | -40°C up to +75°C |
| Strain Relief to | 100 N |
| Manufacturer | tde |

Optical performance

| Fiber | Type | Wavelength | Insertion loss typ. | Insertion loss max. | Return loss min. |
|-------|------|------------|---------------------|---------------------|------------------|



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| 50/125µ OM4 | LC | 850 / 1300 nm | $\leq 0.07 \text{ dB}$ | 0.15 dB | 35 dB | |
|-------------|----|---------------|------------------------|---------|-------|--|
|-------------|----|---------------|------------------------|---------|-------|--|

FO Adapters

| Туре | MPO/MTP® |
|-----------------|--------------------------|
| Application | Multimode OM4 |
| Design | without Flange |
| Connector style | SC Simplex |
| Key Orientation | Type A, Key up/down |
| Color | Magenta |
| Material | Plastic |
| Sleeve | |
| Shutter | |
| Standards | IEC 61754-7 TIA 604-5 |
| Manufacturer | US Conec |

FO Connectors

The end faces of the connectors are optimized by means of Lasercleaving and machine polish. The MPO/MTP® plug has a defined fiber height of 1 - 3.5μ . The max. adjacent fiber height difference is 0.2μ m and for all fibers 0.3μ m.

Connector

| Туре | MPO/MTP® Male Push Pull Locking with Elite Pins (magenta) | |
|--------------|---|--|
| Ferrule | 12 Fiber MM Elite® ferrule, PPS | |
| Boot colour | Black | |
| Manufacturer | tde/US Conec | |

Optical Performance

| Fiber | Туре | Wavelength | Insertion loss typ. | Insertion loss max. | Return loss min. |
|-------------|----------|--------------|------------------------|---------------------|------------------|
| 50/125μ OM4 | MPO/MTP® | 850 /1300 nm | $\leq 0.12 \text{ dB}$ | 0.25 dB | 35 dB |

FO Fiber

| Туре | Corning ClearCurve® 50/125µ OM4 multimode fiber |
|-----------------------------------|---|
| Optimized Data Rate over Distance | 40/100 Gb over 170 m* 10 Gb/s over 550 m 1 Gb/s over 1100 m |
| Standard Compliance | ISO/IEC 11801: type OM4 fiber** IEC 60793-2-10: type A1a.3 fiber** TIA/EIA: 492AAAD ITU: ITU G651.1 |



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| | Distances specified in the 40G/100G per IEEE 802.3ba standard are 150m on OM4 and 100m on OM3; Corning fibers are manufactured to tighter dispersion specifications and thereby support the extended distances shown in the table (assuming cable attenuation ≤3.0 dB/km and same 1.0 dB of connector loss for OM3 that the standard requires for OM4) |
|----|--|
| ** | Assumes IEC draft standard is harmonized with 492AAAD which was approved by TIA |

Optical Specifications

| Bandwidth | High Performance EMB* (MHz.km): 4700 at 850 nm only Legacy Performance EMB** (MHz.km): 3500 at 850 nm / 500 at 1300 nm |
|--------------------|---|
| Attenuation | At 850 nm max. \leq 2.3 dB/km At 1300 nm max. \leq 0.6 dB/km |
| Macrobend Loss | Mandrel Radius (mm): $37.2 / 15 / 7.5$ Number of Turns: $100 / 2 / 2$ Induced Attenuation (dB) at 850 nm: $\le 0.05 / \le 0.1 / 0.2$ Induced Attenuation (dB) at 1300 nm: $\le 0.15 / \le 0.3 / \le 0.5$ |
| Numerical Aperture | 0.200 ± 0.015 |
| * | Ensured via miniEMBc, per TIA/EIA 455-220A and IEC 60793-1-49, for high performance laser-based systems (up to 10Gb/s) |
| ** | OFL BW, per TIA/EIA 455-204 and IEC 60793-1-41, for legacy and LED-based systems (typically up to 100 Mb/s) |

Dimensional Specifications

| Core Diameter | 50.0 ± 2.5 μm |
|--------------------------------|---------------------------|
| Cladding Diameter | 125.0 ± 1.0 μm |
| Core-Clad Concentricity | ≤ 1.5 μm |
| Cladding Non-Circularity | ≤ 1.0% |
| Core Non-Circularity | ≤ 5.0% |
| Coating Diameter | $242 \pm 5 \mu \text{m}$ |
| Coating-Cladding Concentricity | < 12 μm |

Environmental

| Enviromental Test | Test Condition | Induced Attenuation 850 nm & 1300 nm (dB/km) |
|------------------------------|---------------------------------|--|
| Temperature Dependence | -60°C to +85°C | ≤ 0.10 |
| Temperature Humidity Cycling | -10°C to +85°C and 4% to 98% RH | ≤ 0.10 |
| Water Immersion | 23°C ± 2°C | ≤ 0.20 |
| Heat Aging | 85°C ± 2°C | ≤ 0.20 |
| Damp Heat | 85°C at 85% RH | ≤ 0.20 |
| Operating Temperature Range | -60°C to +85°C | |

Mechanical Specifications

| Proof Test | The entire fiber length is subjected to a tensile stress ≥ 100 kpsi (0.7 GN/m ²). |
|------------|--|
| Length | Fiber lengths available up to 17.6 km/spool. |





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Performance Characterizations

| Refractive Index Difference | 1% |
|-------------------------------------|--|
| Effective Group Index of Refraction | 850 nm: 1.480 1300 nm: 1.479 |
| Fatigue Resistance Parameter (nd) | 20 |
| Coating Strip Force | Dry: 0.6 lbs (2.7N) Wet: 14 days in 23°C water soak: 0.6 lbs (2.7N) |
| Cromatic Dispersion | Zero Dispersion Wavelength (λ_0): 1295 nm $\leq \lambda_0 \leq$ 1315 nm Zero Dispersion Slope (S_0): \leq 0.101 ps/(nm ^{2*} km) |

Product variants & accessories

| ArtNo. | Description |
|---------------------|---|
| TML-M08LCAD/MPP09E | tML® HD - FO Breakout Module 2x MPO/MTP® with Pins/8x LC APC Duplex 9/125μ OS2, LR4 |
| TML-M08LCD/MPP50G3 | tML® HD - FO Breakout Module 2x MPO/MTP® with Pins/8x LC Duplex 50/125µ OM3, SR4 |
| TML-M08LCD/MPP50G4 | tML® HD - FO Breakout Module 2x MPO/MTP® with Pins/8x LC Duplex 50/125µ OM4, SR4 |
| TML-M08LCDS/MPP50G5 | tML® HD - FO Breakout Module 2x MPO/MTP® with Pins/8x LC Duplex 50/125µ OM5, SR4 |